



Attorney Docket No. 0553-0378

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of: )

Shunpei YAMAZAKI et al )

Serial No.: 10/664,642 )

Filed: September 19, 2003 )

Art Unit: 3679 )

Examiner: )

For: FABRICATION SYSTEM AND )  
MANUFACTURING METHOD OF LIGHT EMITTING )  
DEVICE )

I hereby certify that this correspondence  
is being deposited with the United States  
Postal Service as first class mail in an  
envelope addressed to:  
Commissioner for Patents, P.O. Box 1450,  
Alexandria, VA 22313-1450, on March 10,  
2004

Cristie M. Nell

Date: March 10, 2004

**SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

Pursuant to 37 C.F.R. §1.97, as revised on February 4, 1992,  
1135 OG 23-24, Applicant hereby calls the Examiner's attention to  
documents listed on the attached form, which documents may be  
material to the examination of this application. Copies of the  
references are enclosed herewith for the Examiner's consideration.

The family of JP 09-321310 cited herein includes:

EP Patent no. EP 0 810 639 A2

US Patent Published Application no. US 2002/0001888 A1

US Patent no. 6,429,100 B2

The family of JP 11-214700 cited herein includes:

US Patent no. 6,246,387 B1

US Patent Published Application no. US 2001/0024185 A1

US Patent no. 6,496,171 B2

The family of JP 2001-247959 cited herein includes:  
EP Patent no. EP 1 113 087 A2

The family of JP 2002-060926 cited herein includes:  
US Patent Published Application no. US 2002/0011205 A1

The family of JP 2002-158090 cited herein includes:  
US Patent Published Application no. US 2002/0030443 A1

The family of JP 2002-175878 cited herein includes:  
EP Patent no. EP 1 207 557 A2  
US Patent Published Application no. US 2002/0076847 A1

The family of JP 2002-221616 cited herein includes:  
WO Patent no. WO 84/01124  
US Patent Published Application no. US 2002/0067400 A1  
US Patent No. 6,660,332 B2

The family of JP 2003-007464 cited herein includes:  
EP Patent no. EP 1 254 969 A1  
US Patent Published Application no. US 2003/0015140 A1

No inference should be drawn that the attached list sets forth a comprehensive investigation of the prior art, that any or all are pertinent to the invention, or that any apparatus disclosed is equivalent to the subject invention.

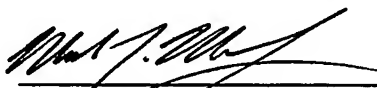
The citation of the above-discussed documents is not to be construed as an assertion that more pertinent art could not possibly be in existence. Citation of any document herein is not to be construed as an admission that any subject matter disclosed in the document is necessarily within the inventive field of endeavor, that any disclosure is necessarily prior in time to a particular date which may be relevant to the instant patent

application, and/or that any disclosure is otherwise necessarily prior art with respect to the instant invention.

Applicant also respectfully reserves the right to later set forth how the instant invention is distinguished over the disclosure of any document or other art, including the disclosure of those documents discussed herein, that may be cited by the Examiner in rejecting a claim in the instant patent application.

A first office action, notice of allowance or issue fee notification has not been received in this case, so Applicant does not believe that a fee is due. However, if any such fee is required, please charge Deposit Account No. 50/1039.

Respectfully submitted,

A handwritten signature in dark ink, appearing to read 'Mark J. Murphy', is written over a horizontal line.

Mark J. Murphy  
Registration No: 34,225

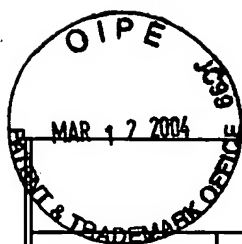
COOK, ALEX, McFARRON, MANZO,  
CUMMINGS & MEHLER, LTD.  
200 West Adams Street  
Suite 2850  
Chicago, Illinois 60606  
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LIST OF PUBLICATIONS CITED BY APPLICANT	<u>Atty Docket No.</u> 0553-0378	<u>Serial No.</u> 10/664,642
	<u>Applicant</u> Shunpei YAMAZAKI et al	
	<u>Filing Date</u> September 19, 2003	<u>Group</u> 3679

**U.S. PATENT DOCUMENTS**

*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE
	6,246,387 B1	06/12/01	Yamazaki	345	92	01/20/99
	US 2001/ 0024185 A1	09/27/01	Yamazaki	345	92	05/03/01
	US 2002/ 0001888 A1	01/03/02	Yoneda	438	166	05/29/97
	US 2002/ 0011205 A1	01/31/02	Yamazaki et al	118	620	03/28/01
	US 2002/ 0030443 A1	03/14/02	Konuma et al	313	504	09/07/01
	US 2002/ 0067400 A1	06/06/02	Kawase et al	347	101	11/20/01
	US 2002/ 0076847 A1	06/20/02	Yamada et al	438	34	09/28/01
	6,429,100 B2	08/06/02	Yoneda	438	487	05/29/97
	6,496,171 B2	12/17/02	Yamazaki	345	92	05/03/01
	US 2003/ 0015140 A1	01/23/03	Van Slyke et al	118	723	04/26/01
	6,660,332 B2	12/09/03	Kawase et al	427	266	11/20/01



### FOREIGN PATENT DOCUMENTS

	DOCUMENT NUMBER	DATE	APPLICANT	English Abstract	English Trans.	FILING DATE
	WO 84/01124	03/29/84	Teknolon OY			09/22/83
	EP 0 810 639	12/03/97	Sanyo Electric Co.			06/02/97
	JP 09-321310	12/12/97	Sanyo Electric Co.	X		05/31/96
	JP 11-214700	08/06/99	Semiconductor	X		01/23/98
	EP 1 113 087	07/04/01	Energy Lab Co. Ltd.			12/27/00
	A2 JP 2001- 237073	08/31/01	Semiconductor Energy Lab Co. Ltd.			
	EP 1 207 557	05/22/02	Tohoku Pioneer Corp.	X		02/24/00
	JP 2002- 158090	05/31/02	Sanyo Electric Co.			09/28/01
	JP 2002- 175878	06/21/02	Semiconductor	X		09/10/01
	JP 2002- 221616	08/09/02	Energy Lab Co. Ltd.	X		09/20/01
	EP 1 254 969	11/06/02	Sanyo Electric Co.	X		09/26/01
	JP 2003- 007464	01/10/03	Seiko Epson Corp.			04/15/02
	JP 2003- 293120	10/15/03	Eastman Kodak Co.	X		04/24/02
			Eastman Kodak Co.			
			Ulvac Japan Ltd.	X		04/01/02

### OTHER PRIOR ART - NON PATENT LITERATURE DOCUMENTS

(Include name of author (in CAPITAL LETTERS), title of article or item (book, magazine, journal, serial, symposium, catalog, etc.) date, pages(s), volume-issue number(s), publisher, city and/or country where published).

International Search Report re intl. application no. PCT/JP03/11983,  
mailed December 24, 2003.

EXAMINER:

DATE CONSIDERED:

\*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP form. Draw line through citation if not in conformance and not considered. Include a copy of this form with the next communication to applicant.